

Form No.: QF-1274

Edition: 2

#### ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

### RoHS & Halogen Free & REACH Compliance.

## SPECIFICATION FOR APPROVAL

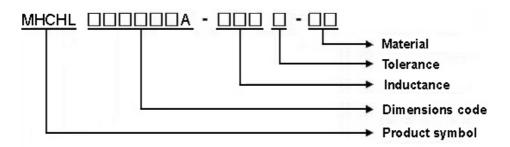
		_
Customer:		
Customer P/N:		
Drawing No:		
Quantity:	0 Pcs. Date:	2016/07/05
Chilisin P/N:	MHCHL252010A	A-1R0M-Q8
	SPECIFICATION ACCEPTED BY:	
COMPONENT		
ENGINEER		
ELECTRICAL		
ENGINEER		
MECHANICAL		
ENGINEER	T .	
APPROVED		
REJECTED		
奇力新電子股份有限公司 Chilisin Electronics Corp No. 29, Alley 301, Tehhsin Rd Hukou, Hsinchu 303, Taiwan TEL: +886-3- 599-2646 FAX: +886-3- 599-9176 E-mail: sales@chilisin.com.tw	Chilisin Electronics ( No. 78, Puxing Rd., ' Area, Qingxi Town, I Guangdong,China TEL: +86-769-8773	Dongguan) Co., Ltd. Yuliangwei Administration Dongguan City, -0251~3 3-0232
奇力新電子(河南)有限公 Chilisin Electronics (Henan) C XiuWu Xian, industry gathering JiaoZuo, Henan China Postal Code:454350 TEL:+86-391-717-0682 FAX:+86-391-717-0666	p., Ltd. <b>鮴川</b> 可益 <b>新电</b> 丁· SUZHOU QI YIXIN E	Electronics Co., Ltd. Rd., Suzhou New District, 1350
Drawn by <b>趙蘭 lan.zhao</b>	Checked by 林青宏 ch.lin	Approved by <b>陳瑞揚 ryan.chen</b>

YG16700185

#### CHILISIN FLECTRONICS CORP.

## **MHCHL252010A Series Specification**

- 1 Scope: This specification applies to Molding power inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature:  $-40 \,^{\circ}\text{C} \sim 125 \,^{\circ}\text{C}$  (Including self - temperature rise)

Storage Temperature:  $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$  (after PCB)

4 Marking:

No Marking

### 5 Standard Testing Condition

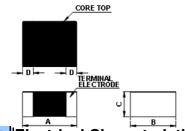
	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35℃)	20 to 30℃
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH



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# MHCHL252010A Series Specification

## 6 Configuration and Dimensions:



Dimensi	Dimensions in mm				
TYPE	MHCHL252010A				
Α	2.5 <u>+</u> 0.3				
В	2.0±0.3				
С	1.0 Max.				
D	0.6±0.3				

### 7 Electrical Characteristics:

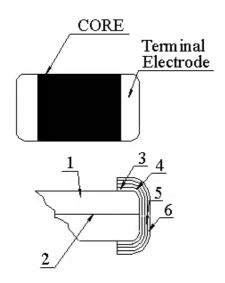
Part No.	Inductance (uH)	Tolerance (±%)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)	SRF (MHz)Typ.
MHCHL252010A-R24M-Q8	0.24	20	2MHz,0.2V	5.5(6.5)	8.0(9.5)	18(13)	126
MHCHL252010A-R33M-Q8	0.33	20	2MHz,0.2V	4.8(5.5)	6.5(8.0)	24(18)	95
MHCHL252010A-R47M-Q8	0.47	20	2MHz,0.2V	3.9(4.5)	5.0(6.2)	35(27)	87
MHCHL252010A-R68M-Q8	0.68	20	2MHz,0.2V	3.7(4.2)	4.5(5.6)	40(32)	53
MHCHL252010A-1R0M-Q8	1	20	2MHz,0.2V	3.0(3.5)	3.7(4.6)	53(45)	41
MHCHL252010A-1R5M-Q8	1.5	20	2MHz,0.2V	2.4(2.8)	3.1(3.8)	75(68)	37
MHCHL252010A-2R2M-Q8	2.2	20	2MHz,0.2V	2.2(2.5)	2.5(3.0)	105(87)	29

#### NOTE:

- 2.Isat for Inductance drop 30% from its value without current.
- 3.Irms for a 40°C temperature rise from 25°C ambient.
- 4.All test data is referenced to 25  $\!\!\!\!\!\!^{\,\circ}_{\,\circ}$  ambient
- 5. Absolute maximum voltage 25 VDC

# 8 MHCHL252010A Series

### 8.1 Construction:



#### 8.2 Material List:

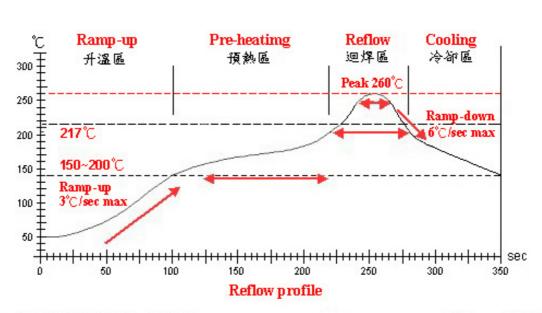
No	Part	Material
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn



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# **MHCHL252010A Series Specification**

No.	echanical Performance Item	Specification	Test Method
	Flexure Strength	The forces applied on the right conditions must not damage	Test device shall be soldered on the substrate Substrate Dimension: 100x40x1.6mm Deflection: 2.0mm Keeping Time: 30sec
1-2	Vibration	Appearance:No damage (for microscope of CASTOR MZ-45 20X) Inductance change shall be within ±20%	Test device shall be soldered on the substrate Oscillation Frequency: 10 to 55 to 10H2 for 1min Amplitude: 1.5mm Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-3	Resistance to Soldering Heat	Appearance: No damage More than 75% of the terminal. electrode should be covered with solder. Inductance: within ±20% of initial value	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 260±5°C Immersion Time: 10±1sec
1-4	Solder ability	The electrodes shall be at least 95% covered with new solder coating	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Flee) Solder Temperature: 245±5°C Immersion Time: 4±1sec
	Terminal Strength Test	No split termination Chip F Mounting Pad	Test device shall be soldered on the substrate then apply a force in the direction of the arrow.  Force: 5N  Keeping Time: 10±1sec
	nvironmental Performance		Toot Mothod
No.	Item	Specification	Test Method
-2-1	Temperature Cycle	Appearance: No damage Inductance:within±20% of initial value	One cycle:         Step         Temperature (℃)         Time (minute)           1         -40±3         30           2         25±2         3           3         125±3         30           4         25±2         3           Total: 100cycles         √           Measured after exposure in the room condition for 24h
2-2	Humidity Resistance		Temperature: 60±2°C Relative Humidity: 90 ~ 95% / Time: 500hrs Measured after exposure in the room condition for 24l
2-3	High Temperature Resistance		Temperature: 85±3°C  Relative Humidity: 0% / Time: 500hrs  Measured after exposure in the room condition for 24l
2-4	Low Temperature Resistance		Temperature: -40±3°C Relative Humidity: 0% / Time: 500hrs Measured after exposure in the room condition for 24l



### Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T. ~150°C	150°C ~ 200°C	217℃	260±5°C	Peak Temp. ~ 150°C
標準時間 Time spec.	_	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	-
實際時間 Time result	_	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	/ <del></del>

#### NOTE:

- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow

### 10 Packaging:

### 10.1 Packaging -Cover Tape

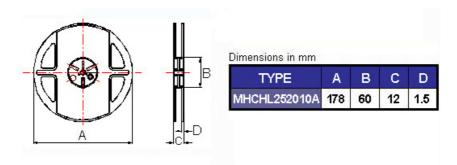
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



### 10.2 Packaging Quantity

TYPE	PCS/REEL
MHCHL252010A	3000

#### 10.3 Reel Dimensions



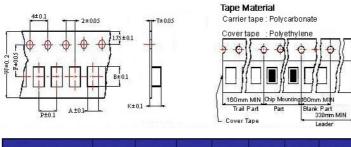


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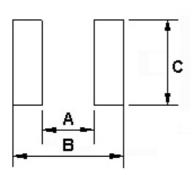
# 10 Packaging:

#### 10.4 Tape Dimensions in mm



TYPE	A	В	T	W	P	F	K
MHCHL252010A	2.25	2.8	0.22	8	4	3.5	1.15

### 11 Recommended Land Pattern:



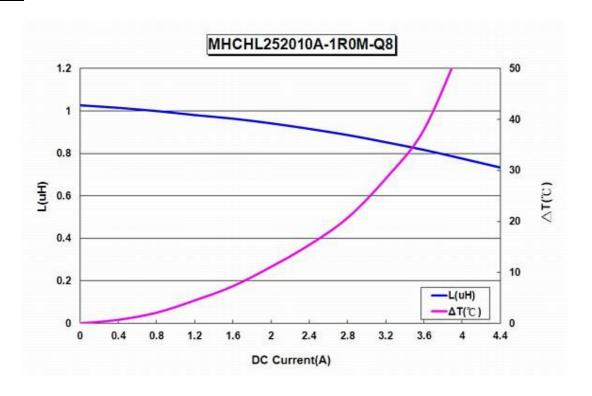
#### Dimensions in mm

TYPE	Α	В	O
MHCHL252010A	1.2	2.8	2.3

### 12 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglected
- 6. The moisture sensitivity level (MSL) of products is classified as level 1.

# 13 Graph:



### 单击下面可查看定价,库存,交付和生命周期等信息

## >>CHILISIN(奇力新)